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Transceiver for KNX Twisted Pair Networks

Introduction

NCN5130 is a receiver−transmitter IC suitable for use in KNX twisted pair networks (KNX TP1−256). It supports the connection of actuators, sensors, microcontrollers, switches or other applications in a building network.

NCN5130 handles the transmission and reception of data on the bus. It generates from the unregulated bus voltage stabilized voltages for its own power needs as well as to power external devices, for example, a microcontroller.

NCN5130 assures safe coupling to and decoupling from the bus. Bus monitoring warns the external microcontroller in case of loss of power so that critical data can be stored in time.

Key Features

- 9600 baud KNX Communication Speed
- Supervision of KNX Bus Voltage and Current
- Supports Bus Current Consumption up to 40 mA
- High Efficient DC−DC Converters
	- \rightarrow 3.3 V Fixed
	- ◆ 1.2 V to 21 V Selectable
- Control and Monitoring of Power Regulators
- Linear 20 V Regulator
- Buffering of Sent Data Frames (Extended Frames Supported)
- Selectable UART or SPI Interface to Host Controller
- Selectable UART and SPI baud Rate to Host Controller
- Optional CRC on UART to the Host
- Optional Received Frame−end with MARKER Service
- Optional Direct Analog Signaling to Host
- Operates with Industry Standard Low Cost 16 MHz Quartz
- Generates Clock of 8 or 16 MHz for External Devices
- Auto Acknowledge (optional)
- Auto Polling (optional)
- Temperature Monitoring
- Extended Operating Temperature Range −40°C to +105°C
- These Devices are Pb−Free and are RoHS Compliant

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QFN40 MN SUFFIX CASE 485AU

MARKING DIAGRAM

A = Assembly Location

 $WL = Water Lot$

- $YY = Year$
- WW = Work Week
- G = Pb−Free Package

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 57 of this data sheet.

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PIN DESCRIPTION

Table 1. PIN LIST AND DESCRIPTION

NOTE: Type of CSB/UC1 and SCK/UC2 is depending on status MODE1 − MODE2 pin Type of XTAL1 and XTAL2 pin is depending on status XSEL pin.

EQUIVALENT SCHEMATICS

Following figure gives the equivalent schematics of the user relevant inputs and outputs. The diagrams are simplified representations of the circuits used.

NOTE: Type of CSB/UC1 and SCK/UC2 is depending on status MODE1 - MODE2 pin Type of XTAL1 and XTAL2 pin is depending on status XSEL pin.

ELECTRICAL SPECIFICATION

Table 2. ABSOLUTE MAXIMUM RATINGS (Notes 1 and 2)

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Convention: currents flowing in the circuit are defined as positive.

2. VBUS2, VSS1, VSS2, VSSA and VSSD form the common ground. They are hard connected to the PCB ground layer.

3. Room temperature, 27 Ω shunt resistor for transmitter, 250 mA over temperature range.

4. Normal performance within the limitations is guaranteed up to the Thermal Warning level. Between Thermal Warning and Thermal Shutdown temporary loss of function or degradation of performance (which ceases after the disturbance ceases) is possible.

5. According to JEDEC JESD22−A114.

Recommend Operation Conditions

Operating ranges define the limits for functional operation and parametric characteristics of the device. Note that the functionality of the chip outside these operating ranges is not guaranteed. Operating outside the recommended operating ranges for extended periods of time may affect device reliability.

Table 3. OPERATING RANGES

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

6. Voltage indicates DC value. With equalization pulse bus voltage must be between 11 V and 45 V.

7. Minimum operating voltage on VIN−pin should be at least 1 V larger than the highest value of VDD1 and VDD2.

8. Higher junction temperature can result in reduced lifetime.

Table 4. DC PARAMETERS The DC parameters are given for a device operating within the Recommended Operating Conditions unless otherwise specified. Convention: currents flowing in the circuit are defined as positive.

Symbol	Pin(s)	Parameter	Remark/Test Conditions	Min	Typ	Max	Unit
POWER SUPPLY							
V _{BUS1}	VBUS1	Bus DC voltage	Excluding active and equalization pulse	20		33	\vee
BUS1_Int		Bus Current Consumption	$VBUS = 30 V$, IBUS = 10 mA, DC2, V20V disabled, no crystal or clock		2.00	2.70	mA
			$VBUS = 20 V$, IBUS = 40 mA		3.50	4.40	
V BUSH		Undervoltage release level	V _{BUS1} rising, see Figure 4	17.1	18.0	18.9	V
V BUSL		Undervoltage trigger level	V _{BUS1} falling, see Figure 4	15.9	16.8	17.7	V
V _{BUS_Hyst}		Undervoltage hysteresis		0.6			\vee
V _{DDD}	VDDD.	Digital Power Supply		3.13	3.3	3.47	V
V_{DDA}	VDDA	Analog Power Supply		3.13	3.3	3.47	V
V_{AUX}		Auxiliary Supply	Internal supply, for info only	2.8	3.3	3.6	V

KNX BUS COUPLER

Symbol Pin(s) Parameter Remark/Test Conditions Min Typ Max Unit

Table 4. DC PARAMETERS The DC parameters are given for a device operating within the Recommended Operating Conditions unless otherwise specified. Convention: currents flowing in the circuit are defined as positive.

Voltage on XTAL−pin V

Voltage on XTAL−pin V

 V_{XTAL}

XTAL1,

Table 4. DC PARAMETERS The DC parameters are given for a device operating within the Recommended Operating Conditions unless otherwise specified. Convention: currents flowing in the circuit are defined as positive.

Table 5. AC PARAMETERS The AC parameters are given for a device operating within the Recommended Operating Conditions unless otherwise specified.

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

Comments: <VBUS> is an internal signal which can be verified with the Internal State Service.

Comments:

<VFILT> is an internal signal which can be verified with the System State Service

Comments: <VDD2> is an internal signal which can be verified with the System State Service

Figure 6. VDD2 Undervoltage Thresholds

Comments: <V20V> is an internal signal which can be verified with the System State Service.

Figure 8. Temperature Monitoring Levels

− WD Timer is an internal timer
− t _{wDTO} = <WDT[3:0]>
− <WDEN> and <WDT[3:0]> are Watchdog Register bits

Figure 9. Watchdog Timing Diagram

Figure 10. SPI Bus Timing Diagram

Figure 11. TREQ Timing Diagram

TYPICAL APPLICATION SCHEMATICS

Figure 12. Typical Application Schematic, 9−bit UART Mode (19200bps), Single Supply, External FANIN Configuration and 8 MHz Microcontroller Clock Signal

TYPICAL APPLICATION SCHEMATICS

Figure 13. Typical Application Schematic, SPI (500 kbps), Dual Supply, 10 mA Bus Current Limit and 0.5 mA/ms Bus Current Slopes, 16 MHz Clock for Microcontroller

TYPICAL APPLICATION SCHEMATICS

Figure 14. Typical Application Schematic, Analog Mode, Single Supply, 20 mA Bus Current Limit and 1.0 mA/ms Bus Current Slopes

Table 6. EXTERNAL COMPONENTS LIST AND DESCRIPTION

9. Component must be between minimum and maximum value to fulfill the KNX requirement.

10.Actual capacitor value depends on X1. If a crystal oscillator is chosen, the capacitors need to be chosen in such a way that the frequency equals 16 MHz. Capacitors are not required if external clock signal is supplied.

11. Voltage of capacitor depends on VDD2 value defined by R4 and R5. See p16 for more details on defining VDD2 voltage value.

12.Reverse polarity diode is mandatory to fulfill the KNX requirement.

13.A clock signal of 16 MHz (50 ppm or less) is mandatory to fulfill the KNX requirements. Or a crystal oscillator of 16 MHz, 50 ppm is used (C8 and C9 need to be of the correct value based on the crystal datasheet), or an external 16 MHz clock is used.

14.It's allowed to short this pin to VFILT-pin

15.High capacitor value might affect the start up time

16.If no resistor connected or pulled up to 3.3 V the KNX device should be certified as a bus load of 10 mA. If shorted to ground the KNX device should be certified as a bus load of 20 mA. If a resistor to ground is connected between 10 k Ω and 93.1 k Ω the device should be certified as a bus load of 10 mA (42.2 k), 20 mA (20 k), 30 mA (13.3 k) or 40 mA (10 k).

17.Total charge of C4 and C7 may not be higher than 121 mC to fulfill the KNX requirement.

ANALOG FUNCTIONAL DESCRIPTION

Because NCN5130 follows the KNX standard only a brief description of the KNX related blocks is given in this datasheet. Detailed information on the KNX Bus can be found on the KNX website (www.knx.org) and in the KNX standards.

KNX Bus Interfacing

Each bit period is $104 \mu s$. Logic 1 is simply the DC level of the bus voltage which is between 20 V and 33 V. Logic 0 is encoded as a drop in the bus voltage with respect to the DC level. Logic 0 is known as the active pulse.

The active pulse is produced by the transmitter and is ideally rectangular. It has a duration of 35 us and a depth between 6 and 9 V (V_{act}). Each active pulse is followed by an equalization pulse with a duration of $69 \mu s$. The latter is an abrupt jump of the bus voltage above the DC level followed by an exponential decay down to the DC level. The equalization pulse is characterized by its height V_{eq} and the voltage V_{end} reached at the end of the equalization pulse.

See the KNX Twisted Pair Standard (KNX TP1−256) for more detailed KNX information.

Figure 15. KNX Bus Voltage versus Digital Value

KNX Bus Transmitter

The purpose of the transmitter is to produce an active pulse (see Figure 15) between 6 V and 9 V regardless of the bus impedance (Note 1). In order to do this the transmitter will sink as much current as necessary until the bus voltage drops by the desired amount.

KNX Bus Receiver

The receiver detects the beginning and the end of the active pulse. The detection threshold for the start of the active pulse is −0.45 V (typ.) below the average bus voltage. The detection threshold for the end of the active pulse is −0.2 V (typ.) below the average bus voltage giving a hysteresis of 0.25 V (typ.).

Bus Coupler

The role of the bus coupler is to extract the DC voltage from the bus and provide a stable voltage supply for the purpose of powering the NCN5130. This stable voltage supplied by the bus coupler is called VFILT, and will follow the average bus voltage. The bus coupler also makes sure that the current drawn from the bus changes very slowly. For this a large filter capacitor is used on the VFILT−pin. Abrupt load current steps are absorbed by the filter capacitor. Long−term stability requires that the average bus coupler input current is equal to the average (bus coupler) load current. This is shown by the parameter $\Delta I_{\text{coupler}}/\Delta t$, which indicates the bus current slope limit. The bus coupler will also limit the current to a maximum of $I_{\text{coupler lim}}$. At startup, this current limit is increased to $I_{\text{coupler lim, startup}}$ to allow for fast charging of the VFILT bulk capacitance.

There are 4 conditions that determine the dimensioning of the VFILT capacitor. First, the capacitor value should be between 12.5 μ F and 4000 μ F to garantuee proper operation of the part. The next requirement on the VFILT capacitor is determined by the startup time of the system. According to the KNX specification, the total startup time must be below 10 s. This time is comprised of the time to charge the VFILT capacitor to 12 V (where the DCDC convertor becomes operatonal) and the startup time of the rest of the system t_{startup,system}. This gives the following formula:

$$
C < \left(10 \text{ s} - t_{statup, system}\right) \times \frac{I_{\text{coupler_llim,statup}}}{V_{\text{FILTH}}}
$$

1. Maximum bus impedance is specified in the KNX Twisted Pair Standard

The third limit on VFILT capacitor value is the required capacitor value to filter out current steps ΔI_{step} of the system without going into reset.

$$
C > \frac{\Delta I_{step}^2}{\left(2\cdot\left(V_{BUS1} - V_{coupler_drop} - V_{FILTL}\right)\cdot\text{I}_{slope}\right)}
$$

The last condition on the size of VFILT is the desired warning time t_{warning} between SAVEB and RESETB in case the bus voltage drops away. This is determined by the current consumption of the system I_{system}.

$$
C > I_{system} \times \frac{\left(t_{warning} + t_{busfilter}\right)}{\left(V_{BUS1} - V_{coupler_drop} - V_{FILTL}\right)}
$$

The bus coupler is implemented as a linear voltage regulator. For efficiency purpose, the voltage drop over the bus coupler is kept minimal (see Table 4).

KNX Impedance Control

The impedance control circuit defines the impedance of the bus device during the active and equalization pulses. The impedance can be divided into a static and a dynamic component, the latter being a function of time. The static impedance defines the load for the active pulse current and the equalization pulse current. The dynamic impedance is produced by a block, called an equalization pulse generator, that reduces the device current consumption (i.e. increases the device impedance) as a function of time during the equalization phase so as to return energy to the bus.

Fixed and Adjustable DC−DC Converter

The device contains two DC−DC buck converters, both supplied from VFILT.

DC1 provides a fixed voltage of 3.3 V. This voltage is used as an internal low voltage supply $(V_{DDA}$ and V_{DDD}) but can also be used to power external devices (VDD1−pin). DC1 is automatically enabled during the power−up procedure (see Analog State Diagram, p23).

DC2 provides a programmable voltage by means of an external resistor divider. It is not used as an internal voltage supply making it not mandatory to use this DC−DC converter (if not needed, tie the VDD2MV pin to VDD1, see also Figure 12).

DC2 can be monitored (<VDD2>, see System Status Service, p37), and/or disabled by a command from the host controller (<DC2EN>, see Analog Control Register 0, p54). DC2 will only be enabled when VFILT–bit is set (<VFILT>, see System Status Service, p37). The status of DC2 can be monitored (<VDD2>, see System Status Service, p37).

The voltage divider can be calculated as follows:

$$
R_4 = R_5 \times \frac{V_{DD2} - 1.2}{1.2}
$$
 (eq. 1)

Both DC−DC converters make use of slope control to improve EMC performance (see Table 5). To operate DC1

and DC2 correctly, the voltage on the VIN−pin should be higher than the highest value of DC1 and DC2.

Although both DC−DC converters are capable of delivering 100 mA, the maximum current capability will not always be usable. One always needs to make sure that the KNX bus power consumption stays within the KNX specification. The maximum allowed current for the DC−DC converters and V20V regulator can be estimated as next:

$$
\frac{V_{BUS} \times (I_{BUS} - I_{20V})}{2 \times [(V_{DD1} \times I_{DD1}) + (V_{DD2} \times I_{DD2})]} \ge 1
$$
 (eq. 2)

IBUS will be limited by the KNX standard and should be lower or equal to I_{coupler} (see Table 4). Minimum V_{BUS} is 20 V (see KNX standard). V_{DD1} and V_{DD2} can be found back in Table 4. I_{DD1} , I_{DD2} and I_{20V} must be chosen in a correct way to be in line with the KNX specification (Note 2).

Although DC2 can operate up to 21 V, it will not be possible to generate this 21 V under all operating conditions. See application note AND9135 for defining the optimum inductor and capacitor of the DC−DC converters. When using low series resistance output capacitors on DC2, it is advised to split the current sense resistor as shown in Figure 18 to reduce ripple current for low load conditions.

V20V Regulator

This is the 20 V low drop linear voltage regulator used to supply external devices. As it draws current from VFILT, this current is seen without any power conversion directly at the VBUS1 pin.

The V20V regulator starts up by default but can be disabled by a command from the host controller (<V20VEN>, see Analog Control Register 0, p54). When the V20V regulator is not used, no load capacitor needs to be connected (see C7 of Figures 12, 13 and 14). Connect V20V−pin with VFILT−pin in this case.

V20V regulator will only be enabled when VFILT−bit is set (<VFILT>, see System Status Service, p37). The host controller can also monitor the status of the regulator (<V20V>, see System Status Service, p37). The 20 V regulator has a current limit that depends on the FANIN resistor value, and the value of bits 0−3 (V20VCLIMIT[0:2]) of the analog control register. In Table 4, the typical value of the current limit at startup is given as $I_{20V\,lim}$ (V20VCLIMIT[0:2] initializes at 100). For each bit difference, the current limit is adjusted up or down by ΔI_{20} V,STEP.

Xtal Oscillator

An analog oscillator cell generates the main clock of 16 MHz. This clock is directly provided to the digital block to generate all necessary clock domains.

An input pin XSEL is foreseen to enable the use of a quartz crystal (see Figure 16) or an external clock generator (see Figure 17) to generate the main clock.

2. The formula is for a typical KNX application. It's only given as guidance and does not guarantee compliance with the KNX standard.

The XCLK−pin can be used to supply a clock signal to the host controller. This clock signal can be switched off by a command from the host controller (<XCLKEN>, see Analog Control Register 0, p54).

After power−up, a 4 MHz (Note 3) clock signal will be present on the XCLK−pin during Stand−By. When Normal State is entered, a 8 or 16 MHz clock signal will be present on the XCLK−pin. See also Figure 20. To output an 8 MHz clock on the XCLK pin, the XCLKC pin must be pulled to ground. When the XCLKC pin is pulled up to VDDD, the XCLK pin will output a 16 MHz clock signal.

When Normal State is left and Stand−By State is re−entered due to an issue different than an Xtal issue, the 8 or 16 MHz clock signal will still be present on the XCLK−pin during the Stand−By State. If however Stand−By is entered from Normal State due to an Xtal issue, the 4 MHz clock signal will be present on the XCLK−pin. See also Table 7.

FANIN−pin

The FANIN−pin defines the maximum allowed bus current and bus current slopes. If the FANIN−pin is kept floating, pulled up to V_{DD} , or pulled down with a resistance higher than $250 \text{ k}\Omega$, NCN5130 will limit the KNX bus current slopes to 0.5 mA/ms at all times. NCN5130 will also limit the KNX bus current to 30 mA during start−up. During normal operation, NCN5130 is capable of taking 10.6 mA $(= I_{\text{coupler}})$ from the KNX bus for supplying external loads (DC1, DC2 and V20V).

If the FANIN−pin is pulled to ground with a resistance smaller than $2 \, k\Omega$ the operation is similar as above with the exception that the KNX bus current slopes will be limited to 1 mA/ms at all times, the KNX bus current will be limited to 60 mA during start−up and up to 20.5 mA (Icoupler) can be taken from the KNX bus during normal operation. When the FANIN−pin is pulled to ground with a resistance between $10 \text{ k}\Omega$ and 93.1 k Ω , the current slope and current limit are defined by the values from Table 4. For different resistor values, the typical current limit can be approximated by the formula Ibus = $0.0004 + 434/R6$ A. Using different resistor values is, however, not recommended.

Definitions for Start−Up and Normal Operation (as given above) can be found in the KNX Specification.

Figure 16. XTAL Oscillator Figure 17. External Clock Generator

Transmit Trigger

When bit 3 of analog control register 0 is set, the TRIG−pin will output a signal that goes high 1 bit time before the start of a scheduled transmission, and goes low when the transmission is complete or a collision is detected. This can be used during development as verification of transmission. Note that a scheduled transmission is a frame that is sent less than $t_{BUS, IDLE}$ (TODO s) after previous communication on the bus. When a frame is transmitted on a bus which has been idle for a longer time, or an ACK/NACK/BUSY response is sent, the transmission will start immediately after the trigger goes high, and the time between trigger high and frame transmission start will not be consistent.

RESETB− and SAVEB−pin

The RESETB signal can be used to keep the host controller in a reset state. When RESETB is low this indicates that the bus voltage is too low for normal operation and that the fixed DC−DC converter has not started up. It could also indicate a Thermal Shutdown (TSD). The RESETB signal also indicates if communication between host and NCN5130 is possible.

The SAVEB signal indicates correct operation. When SAVEB goes low, this indicates a possible issue (loss of bus power or too high temperature) which could trigger the host controller to save critical data or go to a save state. SAVEB goes low immediately when VFILT goes below 14 V (due to sudden large current usage) or after 2 ms when VBUS goes below 20 V. RESETB goes low when VFILT goes below 12 V.

RESETB− and SAVEB−pin are open−drain pins with an internal pull–up resistor to V_{DDD}.

Voltage Supervisors

NCN5130 has different voltage supervisors monitoring VBUS, VFILT, VDD2 and V20V. The general function of a voltage supervisor is to detect when a voltage is above or below a certain level. The levels for the different voltages monitored can be found back in Table 4 (see also Figures 4, 5, 6 and 7).

The status of the voltage supervisors can be monitored by the host controller (see System Status Service, p37).

Depending on the voltage supervisor outputs, the device can enter different states (see Analog State Diagram, p23).

3. The 4 MHz clock signal is internally generated and will be less accurate as the crystal generated clock signal of 8 or 16 MHz.

Figure 18. Fixed (VDD1) and Adjustable (VDD2) DC−DC Converter

18.Only valid when entering Stand−By from Start−Up State.

19.Only valid when entering Stand−By from Normal State.

20.8 MHz or 16 MHz depending on XCLKC.

21.4 MHz signal if Stand−By state was entered due to oscillator issue. Otherwise 8 MHz or 16 MHz clock signal.

22.Only operational if Stand−By state was not entered due to VDD2 or V20V issue.

23.Under certain conditions KNX bus is (partly) active. See Digital State Diagram for more details.

Temperature Monitor

The device produces an over−temperature warning (TW) and a thermal shutdown warning (TSD). Whenever the junction temperature rises above the Thermal Warning level (T_{TW}) , the SAVEB–pin will go low to signal the issue to the host controller. Because the SAVEB−pin will not only go low on a Thermal Warning (TW), the host controller needs to verify the issue by requesting the status (<TW>, see System Status Service, p37). When the junction temperature is above TW, the host controller should undertake actions to reduce the junction temperature and/or store critical data.

When the junction temperature reaches Thermal Shutdown (T_{TSD}) , the device will go to the Reset State. The Thermal Shutdown will be stored (<TSD>, see Analog Status Register, p56) and the analog and digital power supply will be stopped (to protect the device). The device will stay in the Reset State as long as the temperature stays above T_{TSD} .

If the temperature drops below T_{TSD} , Start–Up State will be entered (see also Figure 19). At the moment VDD1 is back up and the OTP memory is read, Stand−By State will be entered and RESETB will go high. The Xtal oscillator will be started. Once the temperature has dropped below T_{TW} and all voltages are high enough, Normal State will be entered. SAVEB will go high and KNX communication is again possible.

The TW−bit will be reset at the moment the junction temperature drops below T_{TW} . The TSD–bit will only be reset when the junction temperature is below T_{TSD} and the <TSD> bit is read (see Analog Status Register, p56).

Figure 8 gives a better view on the temperature monitor.

Watchdog

NCN5130 provides a Watchdog function to the host controller. The Watchdog function can be enabled by means of the WDEN−bit (<WDEN>, see Watchdog Register, p54). Once this bit is set to '1', the host controller needs to re−write this bit to clear the internal timer before the Watchdog Timeout Interval expires (Watchdog Timeout Interval = <WDT>, see Watchdog Register, p54).

In case the Watchdog is acknowledged too early (before t_{WDPR}) or not within the Watchdog Timeout Interval (t_{WDTO}) , the RESETB–pin will be made low (= reset host controller).

Table 8 gives the Watchdog timings t_{WDTO} and t_{WDPR}. Details on <WDT> can be found in the Watchdog Register, p54.

Table 8. WATCHDOG TIMINGS

Analog State Diagram

The analog state diagram of NCN5130 is given in Figure 19. The status of the oscillator, XCLK−pin, DC−DC converters, V20V regulator, serial and KNX communication during the different (analog) states is given in Table 7.

Figure 20 gives a detailed view on the start−up behavior of NCN5130. After applying the bus voltage, the filter capacitor starts to charge. During this Reset State, the current drawn from the bus is limited to I_{coupler} (for details see the KNX Standards). Once the voltage on the filter capacitor reaches 10 V (typ.), the fixed DC−DC converter (powering VDDA) will be enabled and the device enters the Start–Up State. When V_{DD1} gets above 2.8 V (typ.), the OTP memory is read out to trim some analog parameters (OTP memory is not accessible by the user). When done, the Stand−By State is entered and the RESETB−pin is made high. If at this moment V_{BUS} is above V_{BUSH} , the VBUS–bit will be set (<VBUS>, see System Status Service, p37). After aprox. 2 ms the Xtal oscillator will start. When $V_{\text{FII},T}$ is above V_{FILTH} DC2 and V20V will be started. When the Xtal oscillator has started, no Thermal Warning (TW) or Thermal Shutdown (TSD) was detected and the VBUS−, VFILT−, VDD2− and V20V−bits are set, the Normal State will be entered and SAVEB−pin will go high.

Figure 21 gives a detailed view on the shut−down behavior. If the KNX bus voltage drops below V_{BUSL} for more than tbus_filter, the VBUS−bit will be reset (<VBUS>, see System Status Service, p37) and the Standy−By State is entered. SAVEB will go low to signal this. When VFILT drops below V_{FITL} , DC2 and the V20V regulator will be switched off. When VFILT drops below 6.5 V (typ), DC1 will be switched off and V_{DD1} drops below 2.8 V (typ.) the device goes to Reset State (RESETB low).

Analog Output

A multiplexed analog signal is available on the ANAOUT−pin for monitoring signal levels. The signal read out on this pin can be configured through the Analog Output Control bits (<ANAOUTCTRL>, see Analog Control Register 1, p 52).

Remarks:

− <TW>, <XTAL>, <VBUS>, <VFILT>, <VDD2> and <V20V> are internal status bits which can be verified with the System State Service.

− <TSD> is an internal signal indicating a Thermal Shutdown. This internal signal cannot be read out.

− Although Reset State could be entered from Normal State on a TSD, Stand−By State will be entered first due to a TW.

Figure 19. Analog State Diagram

Figure 21. Shut−Down Behavior